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Please read this notice before using the TAIYO YUDEN products.



REMINDERS

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Please note that Taiyo Yuden Co., Ltd. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact Taiyo Yuden Co., Ltd. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact Taiyo Yuden Co., Ltd. for more detail in advance.

Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

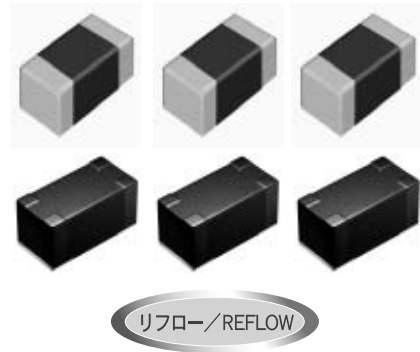
In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN' s official sales channel"). It is only applicable to the products purchased from any of TAIYO YUDEN' s official sales channel.
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Should you have any question or inquiry on this matter, please contact our sales staff.

巻線チップパワーインダクタ

WOUND CHIP POWER INDUCTORS

CB SERIES



OPERATING TEMP.	-25~+105°C (製品自己発熱含む) (Including self-generated heat)
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特長 FEATURES

- LB / LBC シリーズに対し大電流化に対応しています。小型のDC/DCコンバータに使用する、チョーク用途に適した巻線チップインダクタです。
- CBMF 1608
一面電極構造採用により、最大効率設計を実現。DC/DCコンバータなど大電流を必要とする回路設計に適したチップインダクタです。

This series correspond to high electric current compared with LB/LBC series.
Wound Chip Inductors that can be used for small DC/DC converters and are suit for choke uses.

- CBMF1608 Series
The best efficiency design is achieved by adopting bottom-surface electrode structure.
Wound Chip Inductors that are suit for module design which needs high electric current like DC/DC converters.

用途 APPLICATIONS

- DSC / DVC / HDD、液晶、携帯電話、ゲーム機器、各種映像機器、各種通信機器など

- DSC/DVC/HDD, LCD, portable telephones, game equipments.
Various audio-visual equipments, various communication equipments, etc.

形名表記法 ORDERING CODE

1

形式	
CB	巻線チップパワーインダクタ

3

外形寸法 [mm]	
1608 (0603)	1.6×0.8
2012 (0805)	2.0×1.25
2016 (0806)	2.0×1.6
2518 (1007)	2.5×1.8
3225 (1210)	3.2×2.5

5

公称インダクタンス [μH]	
例	
1R0	1
100	10
101	100

※R=小数点

6

インダクタンス許容差 [%]	
K	±10
M	±20

2

特性仕様	
△	低Rdc
C	大電流
L	低背
MF	下面電極

4

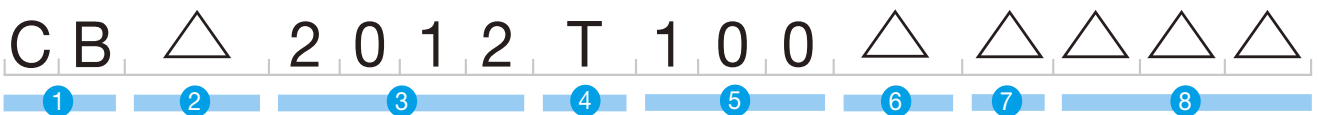
包装	
T	テーピング

7

個別仕様	
△	標準品
R	低Rdc品

8

当社管理記号	
△△△	標準品
△	△=スペース



1

Type	
CB	Wound chip power inductor

3

External Dimensions [mm]	
1608 (0603)	1.6×0.8
2012 (0805)	2.0×1.25
2016 (0806)	2.0×1.6
2518 (1007)	2.5×1.8
3225 (1210)	3.2×2.5

5

Nominal Inductance [μH]	
example	
1R0	1
100	10
101	100

*R=decimal point

6

Inductance Tolerances [%]	
K	±10
M	±20

2

Characteristic Spec	
△	Low Rdc
C	High current
L	Low profile
MF	Bottom-surface electrode

4

Packaging	
T	Tape & Reel

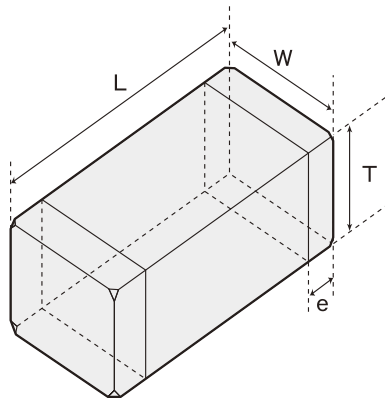
7

Special code	
△	Standard products
R	Low Rdc type

8

Internal code	
△△△	Standard Products
△	△ = Blank space

外形寸法 EXTERNAL DIMENSIONS



Type	L	W	T	e
CBC3225	3.2±0.2 (0.126±0.008)	2.5±0.2 (0.098±0.008)	2.5±0.2 (0.098±0.008)	0.6±0.3 (0.024±0.012)
CB2518 CBC2518	2.5±0.2 (0.098±0.008)	1.8±0.2 (0.071±0.008)	1.8±0.2 (0.071±0.008)	0.5±0.2 (0.020±0.008)
CB2016 CBC2016	2.0±0.2 (0.079±0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.2 (0.020±0.008)
CB2012 CBC2012	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	1.25±0.2 (0.049±0.008)	0.5±0.2 (0.020±0.008)
CBL2012	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	0.9±0.1 (0.035±0.004)	0.5±0.2 (0.020±0.008)
CBMF1608	1.6±0.2 (0.063±0.2)	0.8±0.2 (0.031±0.008)	0.8±0.2 (0.031±0.008)	0.45±0.15 (0.015±0.006)

Unit : mm (inch)

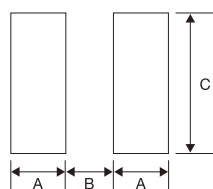
推奨ランドパターン Recommended Land Patterns

実装上の注意

- ・実装状態を確認の上ご使用下さいませようお願いいたします。
- ・本製品のはんだ付けはリフローはんだ工法に限ります。
- ・推奨ランドパターン

Surface Mounting

- ・Mounting and soldering conditions should be checked beforehand.
- ・Applicable soldering process to this products is reflow soldering only.
- ・Recommended Land Patterns



Unit : mm

TYPE	A	B	C
1608	0.55	0.7	1.0
MF1608	0.55	0.8	1.0
2012	0.7	0.8	1.45
2016	0.7	0.8	1.8
2518	0.8	1.2	2.0
3225	1.0	1.6	2.7

概略バリエーション AVAILABLE INDUCTANCE RANGE

Range	Type	CB2518	CB2016	CB2012	CBC3225	CBC2518	CBC2016	CBC2012	CBL2012	CBMF1608
1		1200 1μH 0.06	600 1μH 0.09	500 1μH 0.15	1440 1μH 0.055	1000 1μH 0.08	1100 1μH 0.1	700 1μH 0.19	620 1μH 0.15	350 1μH 0.09
2.2		510 0.09	510 0.13	410 0.23	1130 0.08	890 0.13	750 0.2	530 0.33	440 0.39	230 0.17
10		250 0.25	250 0.5	200 0.5	900 0.133	480 0.36	380 0.82	240 1.2	205 1.0	115 0.36
47		110 0.95	110 2.4	90 3.7	390 0.67	240 1.90	150 4.3	120 5.8	100 4.2	50 2.5
100		60 2.1	70 4.5	60 7	270 1.4	160 3.7	110 8			
1000		25 24	100μH	100μH	100μH	65 28	100μH			

代表値 Examples	Inductance	Imax [mA]	Rdc±30% [Ω]	Imax [mA]	Rdc±30% [Ω]	Imax [mA]	Rdc±30% [Ω]	Imax [mA]	Rdc±30% [Ω]	Imax [mA]	Rdc±30% [Ω]	Imax [mA]	Rdc±30% [Ω]	Imax [mA]	Rdc±30% [Ω]	Imax [mA]	Rdc±30% [Ω]	Imax [mA]	Rdc±30% [Ω]
	1μH	1200	0.06	600	0.09	500	0.15	1440	0.055	1000	0.08	1100	0.1	700	0.19	620	0.15	350	0.09
2.2μH	510	0.09	510	0.13	410	0.23	1130	0.08	890	0.13	750	0.2	530	0.33	440	0.39	230	0.17	
10μH	250	0.25	250	0.5	200	0.5	900	0.133	480	0.36	380	0.82	240	1.2	205	1.0	115	0.36	
47μH	110	0.95	110	2.4	90	3.7	390	0.67	240	1.9	150	4.3	120	5.8	100	4.2	50	2.5	
100μH	60	2.1	70	4.5	60	7	270	1.4	160	3.7	110	8	—	—	—	—	—	—	

セレクションガイド Selection Guide

アイテム一覧 Part Numbers

特性図 Electrical Characteristics

梱包 Packaging

信頼性 Reliability Data

使用上の注意 Precautions



etc

アイテム一覧 PART NUMBERS

CB2012 TYPE

形名 Ordering code	EHS (Environmental Hazardous Substances)	公称 インダクタンス Inductance [μH]	インダクタンス 許容差 Inductance Tolerance	自己共振 周波数 Self-resonant frequency [MHz] min.	直流抵抗 DC Resistance [Ω] (±30%)	定格電流※) Rated current [mA]		測定 周波数 Measuring frequency [MHz]
						直流重畳許容電流 Saturation current Idc1	温度上昇許容電流 Temperature rise current Idc2	
CB 2012T1R0M	RoHS	1.0	±20%	100	0.15	500	900	7.96
CB 2012T2R2M	RoHS	2.2		80	0.23	410	770	
CB 2012T3R3M	RoHS	3.3		55	0.30	330	650	
CB 2012T4R7M	RoHS	4.7		45	0.40	300	580	
CB 2012T6R8M	RoHS	6.8		35	0.47	250	540	
CB 2012T100□	RoHS	10	±10% ±20%	32	0.70	190	440	2.52
CB 2012T100□R	RoHS	10		32	0.50	200	520	
CB 2012T150□	RoHS	15		28	1.3	170	320	
CB 2012T220□	RoHS	22		16	1.7	135	280	
CB 2012T470□	RoHS	47		11	3.7	90	190	
CB 2012T680□	RoHS	68		10	6.0	70	140	
CB 2012T101□	RoHS	100		8	7.0	60	130	

CB2016 TYPE

形名 Ordering code	EHS (Environmental Hazardous Substances)	公称 インダクタンス Inductance [μH]	インダクタンス 許容差 Inductance Tolerance	自己共振 周波数 Self-resonant frequency [MHz] min.	直流抵抗 DC Resistance [Ω] (±30%)	定格電流※) Rated current [mA]		測定 周波数 Measuring frequency [MHz]
						直流重畳許容電流 Saturation current Idc1	温度上昇許容電流 Temperature rise current Idc2	
CB 2016T1R0M	RoHS	1.0	±20%	100	0.09	600	1100	7.96
CB 2016T1R5M	RoHS	1.5		80	0.11	550	1000	
CB 2016T2R2M	RoHS	2.2		70	0.13	510	1000	
CB 2016T3R3M	RoHS	3.3		55	0.20	400	800	
CB 2016T4R7M	RoHS	4.7		45	0.25	340	740	
CB 2016T6R8M	RoHS	6.8		38	0.35	300	600	
CB 2016T100□	RoHS	10	±10% ±20%	32	0.50	250	520	2.52
CB 2016T150□	RoHS	15		28	0.70	210	440	
CB 2016T220□	RoHS	22		16	1.0	165	370	
CB 2016T330□	RoHS	33		14	1.7	130	270	
CB 2016T470□	RoHS	47		11	2.4	110	240	
CB 2016T680□	RoHS	68		10	3.0	90	210	
CB 2016T101□	RoHS	100		8	4.5	70	170	

CB2518 TYPE

形名 Ordering code	EHS (Environmental Hazardous Substances)	公称 インダクタンス Inductance [μH]	インダクタンス 許容差 Inductance Tolerance	自己共振 周波数 Self-resonant frequency [MHz] min.	直流抵抗 DC Resistance [Ω] (±30%)	定格電流※) Rated current [mA]		測定 周波数 Measuring frequency [MHz]
						直流重畳許容電流 Saturation current Idc1	温度上昇許容電流 Temperature rise current Idc2	
CB 2518T1R0M	RoHS	1.0	±20%	100	0.06	1200	1500	7.96
CB 2518T1R5M	RoHS	1.5		80	0.07	650	1400	
CB 2518T2R2M	RoHS	2.2		68	0.09	510	1300	
CB 2518T3R3M	RoHS	3.3		54	0.11	440	1200	
CB 2518T4R7MR	RoHS	4.7		46	0.10	310	1200	
CB 2518T4R7M	RoHS	4.7		46	0.13	340	1100	
CB 2518T6R8M	RoHS	6.8		38	0.15	270	930	
CB 2518T100□	RoHS	10	±10% ±20%	30	0.25	250	820	2.52
CB 2518T150□	RoHS	15		23	0.32	180	650	
CB 2518T220□	RoHS	22		19	0.50	165	580	
CB 2518T330□	RoHS	33		15	0.70	130	460	
CB 2518T470□	RoHS	47		12	0.95	110	420	
CB 2518T680□	RoHS	68		9.5	1.5	70	310	
CB 2518T101□	RoHS	100		9.0	2.1	60	260	
CB 2518T151□	RoHS	150		7.0	3.2	55	210	
CB 2518T221□	RoHS	220		5.5	4.5	50	180	
CB 2518T331□	RoHS	330		4.5	7.0	40	140	
CB 2518T471□	RoHS	470	3.5	10	35	120		
CB 2518T681□	RoHS	680	3.0	17	30	90		
CB 2518T102□	RoHS	1000	2.4	24	25	75		
								0.252

(注) 形名の□にはインダクタンス許容差記号(MまたはK)が入ります。

□Please specify the Inductance tolerance code(Kor M)

※) 直流重畳許容電流 (Idc1) は、直流重畳によるインダクタンス低下が30%以内となる直流電流値 (at 20°C)

The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

※) 温度上昇許容電流 (Idc2) は、温度上昇が40°Cとなる直流電流値 (at 20°C)

The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)

※) 最大定格電流値は直流重畳許容電流、または温度上昇許容電流をいずれも満足する直流電流値

The maximum rated current is the DC current value that satisfies both of DC saturation current value and temperature rise current value.

CBC2012 TYPE

形名 Ordering code	EHS (Environmental Hazardous Substances)	公称 インダクタンス Inductance [μH]	インダクタンス 許容差 Inductance Tolerance	自己共振 周波数 Self-resonant frequency [MHz] min.	直流抵抗 DC Resistance [Ω] (±30%)	定格電流 ※) Rated current [mA]		測定 周波数 Measuring frequency [MHz]
						直流重量許容電流 Saturation current Idc1	温度上昇許容電流 Temperature rise current Idc2	
CB C2012T1R0M	RoHS	1.0	±20%	100	0.19	700	840	7.96
CB C2012T2R2M	RoHS	2.2		70	0.33	530	640	
CB C2012T4R7M	RoHS	4.7		45	0.50	360	520	
CB C2012T100□	RoHS	10	±10%	40	1.2	240	340	2.52
CB C2012T220□	RoHS	22		16	3.7	170	190	
CB C2012T470□	RoHS	47		11	5.8	120	150	

CBC2016 TYPE

形名 Ordering code	EHS (Environmental Hazardous Substances)	公称 インダクタンス Inductance [μH]	インダクタンス 許容差 Inductance Tolerance	自己共振 周波数 Self-resonant frequency [MHz] min.	直流抵抗 DC Resistance [Ω] (±30%)	定格電流 ※) Rated current [mA]		測定 周波数 Measuring frequency [MHz]
						直流重量許容電流 Saturation current Idc1	温度上昇許容電流 Temperature rise current Idc2	
CB C2016T1R0M	RoHS	1.0	±20%	100	0.10	1100	1100	7.96
CB C2016T1R5M	RoHS	1.5		80	0.15	1000	1000	
CB C2016T2R2M	RoHS	2.2		70	0.20	750	720	
CB C2016T3R3M	RoHS	3.3		55	0.27	600	610	
CB C2016T4R7M	RoHS	4.7		45	0.37	550	530	
CB C2016T6R8M	RoHS	6.8		38	0.59	450	450	
CB C2016T100□	RoHS	10	±10%	32	0.82	380	350	2.52
CB C2016T150□	RoHS	15		28	1.2	300	300	
CB C2016T220□	RoHS	22		16	1.8	250	240	
CB C2016T330□	RoHS	33		14	2.8	220	220	
CB C2016T470□	RoHS	47		11	4.3	150	150	
CB C2016T680□	RoHS	68		10	7.0	130	130	
CB C2016T101□	RoHS	100	±20%	8	8.0	110	110	0.796

CBC2518 TYPE

形名 Ordering code	EHS (Environmental Hazardous Substances)	公称 インダクタンス Inductance [μH]	インダクタンス 許容差 Inductance Tolerance	自己共振 周波数 Self-resonant frequency [MHz] min.	直流抵抗 DC Resistance [Ω] (±30%)	定格電流 ※) Rated current [mA]		測定 周波数 Measuring frequency [MHz]
						直流重量許容電流 Saturation current Idc1	温度上昇許容電流 Temperature rise current Idc2	
CB C2518T1R0M	RoHS	1.0	±20%	100	0.08	1000	1200	7.96
CB C2518T1R5M	RoHS	1.5		80	0.11	950	1190	
CB C2518T2R2M	RoHS	2.2		68	0.13	890	1100	
CB C2518T3R3M	RoHS	3.3		54	0.16	730	1020	
CB C2518T4R7M	RoHS	4.7		41	0.20	680	920	
CB C2518T6R8M	RoHS	6.8		38	0.30	550	740	
CB C2518T100□	RoHS	10	±10%	30	0.36	480	680	2.52
CB C2518T150□	RoHS	15		23	0.65	350	500	
CB C2518T220□	RoHS	22		19	0.77	320	460	
CB C2518T330□	RoHS	33		15	1.5	270	320	
CB C2518T470□	RoHS	47		12	1.9	240	290	
CB C2518T680□	RoHS	68		9.5	2.8	200	200	
CB C2518T101□	RoHS	100	±20%	9.0	3.7	160	170	0.796
CB C2518T151□	RoHS	150		7.0	6.1	140	130	
CB C2518T221□	RoHS	220		5.5	8.4	115	110	
CB C2518T331□	RoHS	330		4.5	12.3	100	90	
CB C2518T471□	RoHS	470		3.5	22	80	70	
CB C2518T681□	RoHS	680		3.0	28	65	60	

(注) 形名の□にはインダクタンス許容差記号(MまたはK)が入ります。
 ・□Please specify the Inductance tolerance code (Kor M)

※) 直流重量許容電流 (Idc1) は、直流重量によるインダクタンス低下が30%以内となる直流電流値 (at 20°C)
 The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

※) 温度上昇許容電流 (Idc2) は、温度上昇が40°Cとなる直流電流値 (at 20°C)
 The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)

※) 最大定格電流値は直流重量許容電流、または温度上昇許容電流をいずれも満足する直流電流値
 The maximum rated current is the DC current value that satisfies both of DC saturation current value and temperature rise current value.

CBC3225 TYPE

形名 Ordering code	EHS (Environmental Hazardous Substances)	公称 インダクタンス Inductance [μH]	インダクタンス 許容差 Inductance Tolerance	自己共振 周波数 Self-resonant frequency [MHz] min.	直流抵抗 DC Resistance [Ω] (±30%)	定格電流 ※) Rated current [mA]		測定 周波数 Measuring frequency [MHz]
						直流重畳許容電流 Saturation current Idc1	温度上昇許容電流 Temperature rise current Idc2	
CB C3225T1R0MR	RoHS	1.0	±20%	250	0.055	2000	1440	0.1
CB C3225T1R5MR	RoHS	1.5		220	0.06	2000	1310	
CB C3225T2R2MR	RoHS	2.2		190	0.08	2000	1130	
CB C3225T3R3MR	RoHS	3.3		160	0.095	2000	1040	
CB C3225T4R7MR	RoHS	4.7		70	0.10	1250	1010	
CB C3225T6R8MR	RoHS	6.8	±10% ±20%	50	0.12	930	940	
CB C3225T100□R	RoHS	10		23	0.133	900	900	
CB C3225T150□R	RoHS	15		20	0.195	730	850	
CB C3225T220□R	RoHS	22		17	0.27	620	780	
CB C3225T330□R	RoHS	33		13	0.41	500	570	
CB C3225T470□R	RoHS	47		10	0.67	390	480	
CB C3225T680□R	RoHS	68	±20%	8	1.0	320	410	
CB C3225T101□R	RoHS	100		6	1.4	270	340	

CBL2012 TYPE

形名 Ordering code	EHS (Environmental Hazardous Substances)	公称 インダクタンス Inductance [μH]	インダクタンス 許容差 Inductance Tolerance	自己共振 周波数 Self-resonant frequency [MHz] min.	直流抵抗 DC Resistance [Ω] (±30%)	定格電流 ※) Rated current [mA]		測定 周波数 Measuring frequency [MHz]
						直流重畳許容電流 Saturation current Idc1	温度上昇許容電流 Temperature rise current Idc2	
CB L2012T1R0M	RoHS	1.0	±20%	100	0.15	620	950	0.1
CB L2012T2R2M	RoHS	2.2		80	0.39	440	590	
CB L2012T4R7M	RoHS	4.7		45	0.66	275	490	
CB L2012T100M	RoHS	10		32	1.0	205	370	
CB L2012T220M	RoHS	22		23	2.1	150	250	
CB L2012T470M	RoHS	47		11	4.2	100	140	

CBMF1608 TYPE

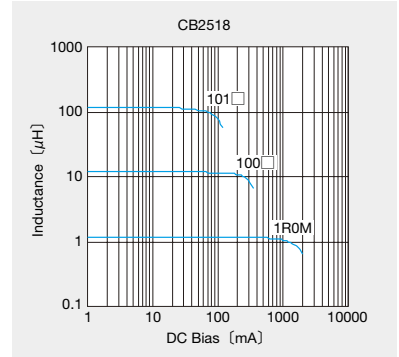
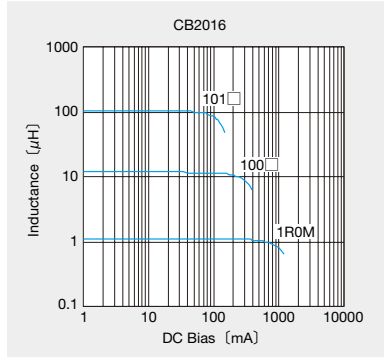
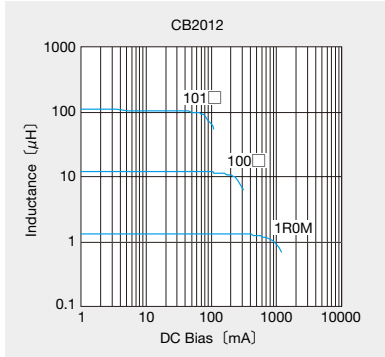
形名 Ordering code	EHS (Environmental Hazardous Substances)	公称 インダクタンス Inductance [μH]	インダクタンス 許容差 Inductance Tolerance	自己共振 周波数 Self-resonant frequency [MHz] min.	直流抵抗 DC Resistance [Ω] (±30%)	定格電流 ※) Rated current [mA]		測定 周波数 Measuring frequency [MHz]
						直流重畳許容電流 Saturation current Idc1	温度上昇許容電流 Temperature rise current Idc2	
CB MF1608T1R0M	RoHS	1.0	±20%	100	0.09	290	770	7.96
CB MF1608T2R2M	RoHS	2.2		80	0.17	190	560	
CB MF1608T3R3M	RoHS	3.3		60	0.22	170	500	
CB MF1608T4R7M	RoHS	4.7		45	0.24	145	470	
CB MF1608T100□	RoHS	10.0	±10% ±20%	32	0.36	115	380	2.52
CB MF1608T220□	RoHS	22		16	1.0	70	230	
CB MF1608T470□	RoHS	47		11	2.5	50	140	

(注) 形名の□にはインダクタンス許容差記号(MまたはK)が入ります。
 □Please specify the Inductance tolerance code (K or M)

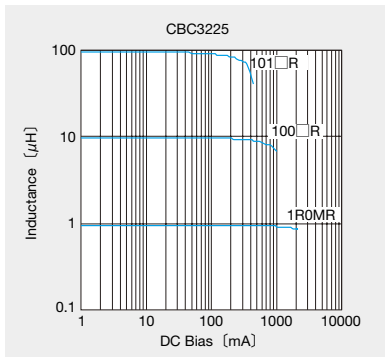
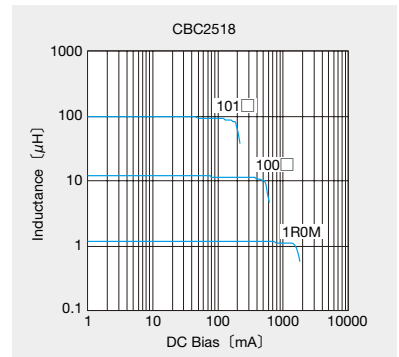
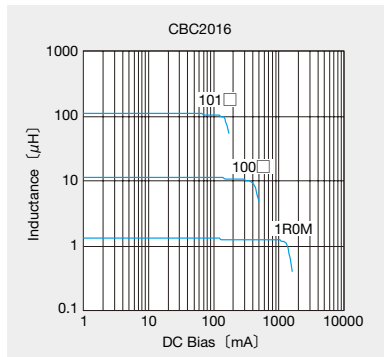
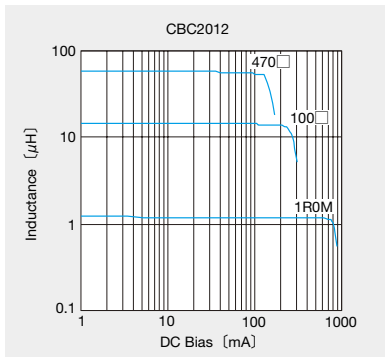
- ※) 直流重畳許容電流 (Idc1) は、直流重畳によるインダクタンス低下が30%以内となる直流電流値 (at 20°C)
 The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)
- ※) 温度上昇許容電流 (Idc2) は、温度上昇が40°Cとなる直流電流値 (at 20°C)
 The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)
- ※) 最大定格電流値は直流重畳許容電流、または温度上昇許容電流をいずれも満足する直流電流値
 The maximum rated current is the DC current value that satisfies both of DC saturation current value and temperature rise current value.

直流重畳特性例 DC Bias characteristics (Measured by HP4285A+42841A)

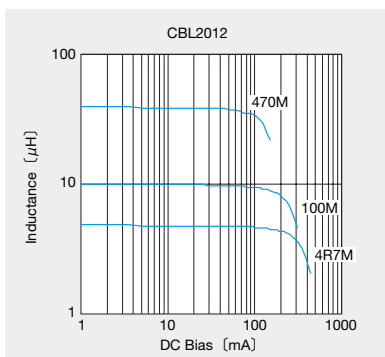
○低抵抗品 Low Rdc Type



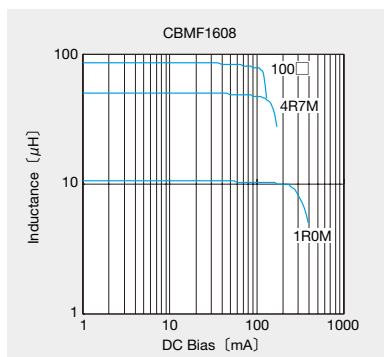
○大電流品 High Current Type



○低背品 Low Profile Type

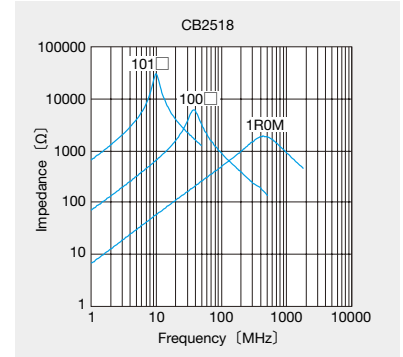
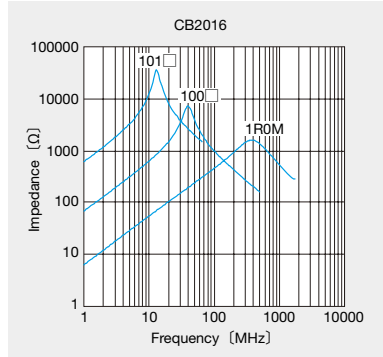
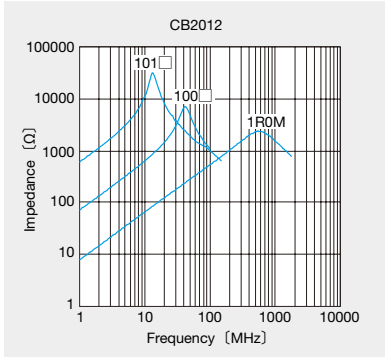


○下面電極品 Bottom-surface electrode Type

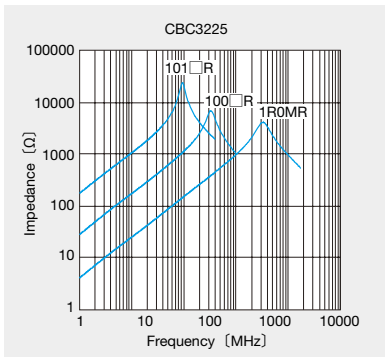
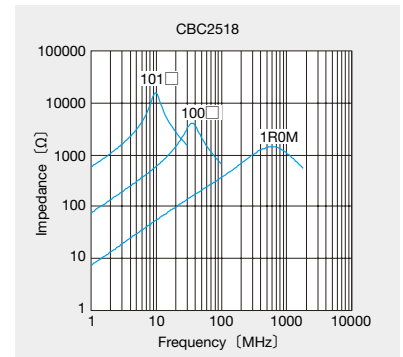
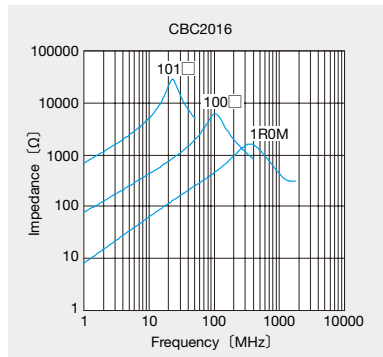
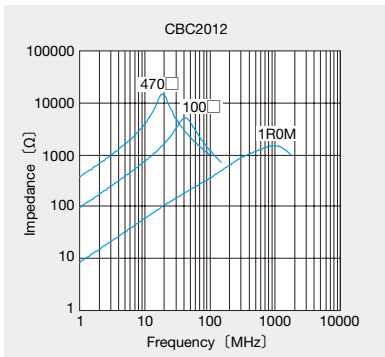


インピーダンス周波数 Impedance-vs-Frequency characteristics (Measured by HP4291A)

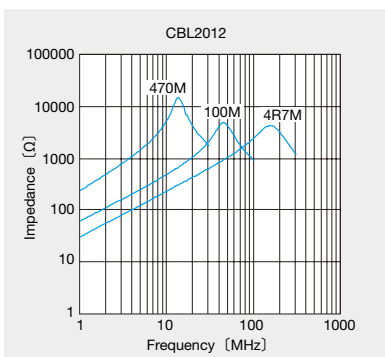
○低抵抗品 Low Rdc Type



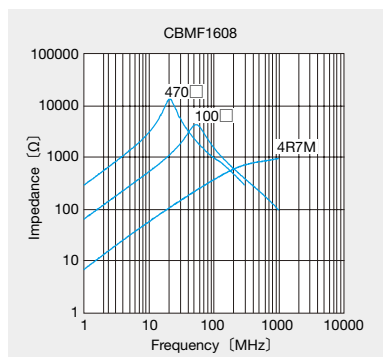
○大電流品 High Current Type



○低背品 Low Profile Type



○下面電極品 Bottom-surface electrode Type

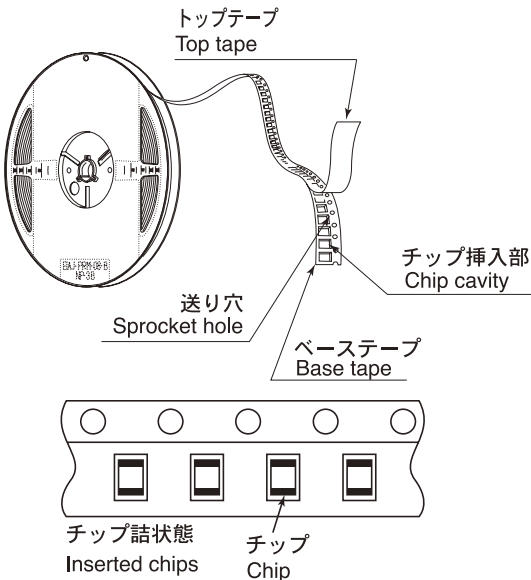


①最小受注単位数 Minimum Quantity

形式 Type	標準数量 Standard Quantity [pcs]	
	紙テーピング Paper Tape	エンボステーピング Embossed Tape
CBC3225	—	1000
LB3218	—	2000
LBR2518/LBC2518/LB2518 /CB2518/CBC2518/LEM2520	—	2000
LBM2016/LBC2016/LB2016 /CB2016/CBC2016	—	2000
LB2012/LBC2012/LBR202 /CB2012/CBC2012	—	3000
CBL2012	4000	—
LB1608	4000	—
LBMF1608/CBMF1608	—	3000

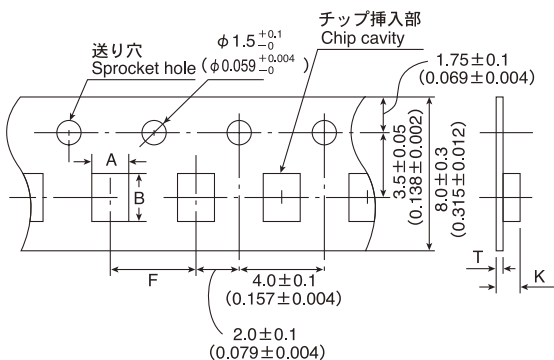
②テーピング材質 Tape material

エンボステープ Embossed tape



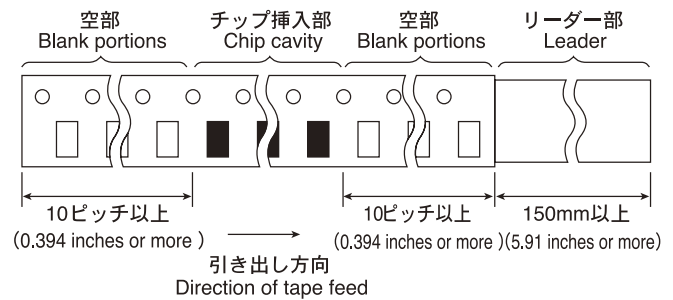
③テーピング寸法 Taping Dimensions

エンボステープ (8mm幅) Embossed Tape (0.315 inches wide)
紙テープ (8mm幅) Card board carrier tape (0.315 inches wide)

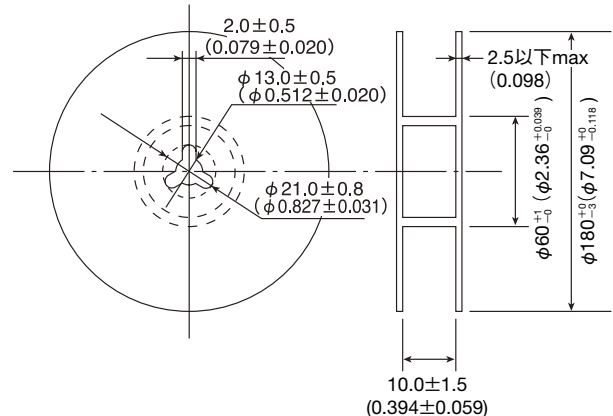


形式 Type	チップ挿入部 Chip cavity		挿入ピッチ Insertion pitch	テープ厚み Tape thickness	
	A	B	F	T	K
LBM 2016	1.9 ± 0.2 (0.075 ± 0.008)	2.2 ± 0.2 (0.087 ± 0.008)	4.0 ± 0.1 (0.157 ± 0.004)	0.3 (0.012)	2.15 (0.085)
LEM 2520	2.3 ± 0.1 (0.091 ± 0.004)	2.7 ± 0.1 (0.106 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	0.3 (0.012)	2.10 (0.083)
CBC3225	2.8 ± 0.1 (0.110 ± 0.004)	3.5 ± 0.1 (0.138 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	0.6max (0.024)	4.0max (0.157)
LB3218	2.1 ± 0.1 (0.084 ± 0.004)	3.5 ± 0.1 (0.014 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	0.3 (0.012)	2.3max (0.092)
LB2518 / CB2518 LBC2518 / CBC2518 LBR2518	2.15 ± 0.2 (0.085 ± 0.008)	2.7 ± 0.2 (0.107 ± 0.008)	4.0 ± 0.1 (0.157 ± 0.004)	0.3 (0.012)	2.10 (0.083)
LB2016 / CB2016 LBC2016 / CBC2016	1.9 ± 0.2 (0.075 ± 0.008)	2.2 ± 0.2 (0.087 ± 0.008)	4.0 ± 0.1 (0.157 ± 0.004)	0.3 (0.012)	2.15 (0.085)
LB2012 / CB2012 LBC2012 / CBC2012 LBR2012	1.45 ± 0.2 (0.058 ± 0.008)	2.25 ± 0.2 (0.09 ± 0.008)	4.0 ± 0.1 (0.157 ± 0.004)	0.25 (0.012)	2.0 (0.079)
CBL2012	1.55 ± 0.2 (0.061 ± 0.008)	2.3 ± 0.2 (0.091 ± 0.008)	4.0 ± 0.1 (0.157 ± 0.004)	1.1max (0.044)	1.1max (0.044)
LB1608	1.0 ± 0.2 (0.059 ± 0.008)	1.8 ± 0.2 (0.072 ± 0.008)	4.0 ± 0.1 (0.157 ± 0.004)	1.1max (0.044)	1.1max (0.044)
LBMF1608 / CBMF1608	1.1 ± 0.1 (0.04 ± 0.004)	1.9 ± 0.1 (0.076 ± 0.004)	3.5 ± 0.05 (0.14 ± 0.002)	0.3max (0.012)	1.6max (0.064)

④リーダー部/空部 Leader and Blank Portion

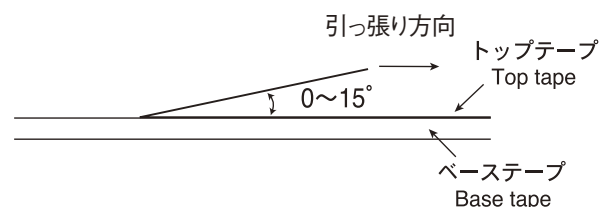


⑤リール寸法 Reel Size

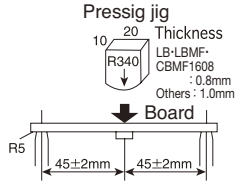


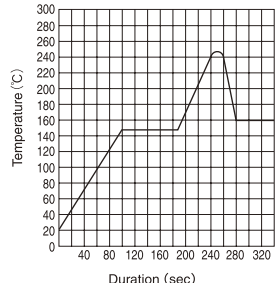
⑥トップテープ強度 Top Tape Strength

トップテープのはがし力は、下図矢印方向にて0.1~0.7Nとなります。
The top tape requires a peel-off force 0.1 to 0.7N in the direction of the arrow as illustrated below.



Item	Specified Value									Test Methods and Remarks	
	LEM2520	LB3218 LB2518 LB2016 LB2012 LB1608 LBMF1608	LBC2518 LBC2016 LBC2012	LBR2518 LBR2012	CB2518 CB2016 CB2012	CBC3225 CBC2518 CBC2016 CBC2012	CBL2012	CBMF1608	LBM2016		
1. Operating temperature Range	-40~+85°C	-25~+105°C (Including self-generated heat)									
2. Storage	-40~+85°C										
3. Rated Current	Within the specified tolerance									LEM · LB · LBC · LBMF · LBM Series The maximum DC value having inductance decrease within 10% and temperature increase within 20°C by the application of DC bias. LBR Series The maximum DC value having inductance decrease within 20% and temperature increase within 20°C by the application of DC bias. CB · CBC · CBL · CBF Series The maximum DC value having inductance decrease within 30% and temperature increase within 40°C by the application of DC bias.	
4. Inductance	Within the specified tolerance									LEM Series R12~101 : Measuring equipment : LCR Meter (HP4285A+42851A or its equivalent) Measuring frequency : Specified frequency LB · LBC · LBR · CB · CBC · CBL · LBMF · CBF · LBM Series : Measuring equipment : LCR Meter (HP4285A or its equivalent)	
5. Q	Within the specified tolerance	/						Within the specified tolerance	LEM Series R12~101 : Measuring equipment : LCR Meter (HP4285A+42851A or its equivalent) Measuring frequency : Specified frequency LBM Series : Measuring equipment : LCR Meter (HP4285A or its equivalent)		
6. DC Resistance	Within the specified tolerance									LEM · LB · LBC · LBR · CB · CBC · CBL · LBM · LBMF · CBF Series : Measuring equipment : DC Ohmmeter (HIOKI 3227 or its equivalent)	
7. Self-Resonant Frequency	Within the specified tolerance									LEM2520 : Measuring equipment : Impedance analyzer (HP4291A or its equivalent) LB · LBC · LBR · CB · CBC · CBL · LBMF · CBF Series : Measuring equipment : Impedance analyzer (HP4291A or its equivalent) LBM Series : Measuring equipment : Network analyzer (HP8720B or its equivalent)	

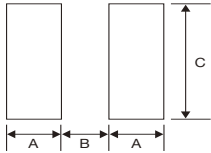
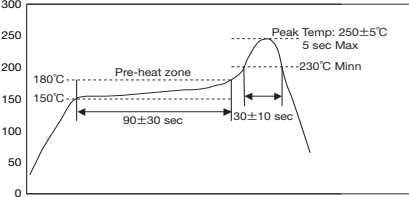
Item	Specified Value									Test Methods and Remarks												
	LEM2520	LB3218 LB2518 LB2016 LB2012 LB1608 LBMF1608	LBC2518 LBC2016 LBC2012	LBR2518 LBR2012	CB2518 CB2016 CB2012	CBC3225 CBC2518 CBC2016 CBC2012	CBL2012	CBMF1608	LBM2016													
8. Temperature Characteristic	Inductance change: Within ± 5%	Inductance change: Within ± 15%	LBC2518 LBC2016 Inductance change: Within ± 20% LBMF1608 LB3218 Inductance change: Within ± 20%	Inductance change: Within ± 15%	Inductance change: Within ± 15%	CBC3225 CBC2518 CBC2016 Inductance change: Within ± 20% CBC2012 Inductance change: Within ± 30%	Inductance change: Within ± 15%	Inductance change: Within ± 20%	Inductance change: Within ± 5%	Change of maximum inductance deviation in step 1-5 <table border="1"> <thead> <tr> <th>Step</th> <th>Temperature (°C)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>20</td> </tr> <tr> <td>2</td> <td>-25</td> </tr> <tr> <td>3</td> <td>20 (Reference temperature)</td> </tr> <tr> <td>4</td> <td>+85 (Maximum operating temperature)</td> </tr> <tr> <td>5</td> <td>20</td> </tr> </tbody> </table>	Step	Temperature (°C)	1	20	2	-25	3	20 (Reference temperature)	4	+85 (Maximum operating temperature)	5	20
Step	Temperature (°C)																					
1	20																					
2	-25																					
3	20 (Reference temperature)																					
4	+85 (Maximum operating temperature)																					
5	20																					
9. Resistance to Flexure of Substrate	No damage.									Warp: 2mm (LB, LBC, LBR, CB, CBC, CBL, LBM, LBMF, CBF Series) : 3mm (LEM2520) Test substrate: Printed board According to JIS C0051 												
10. Body Strength	No damage.									LB · LBC · LBR · CB · CBC · CBL · LBM · LEM2520 Applied force : 10N Duration : 10sec. LB1608 · LBMF1608 · CBF1608 Applied force : 5N Duration : 10sec.												
11. Self Resonant Frequency	Inductance change : Within - 10%		Inductance change: Within - 20%	Inductance change : Within - 30%			Inductance change: Within - 10%		Measure inductance with application of rated current using LCR metre to compare it with the initial value.													
12. Adhesion of terminal electrode	No abnormality.									LB · LBC · LBR · CB · CBC · CBL · LBM · LBMF · CBF · LEM2520 Applied force : 10N to X and Y directions Duration : 5 sec. Test substrate : Printed board												
13. Resistance to vibration	Inductance change: Within ± 5%	Inductance change : Within ± 10% No significant abnormality in appearance.						Inductance change: Within ± 5%	No significant abnormality in appearance.		LEM · LB · LBC · LBR · CB · CBC · CBL · LBM · LBMF · CBF : According to JIS C5102 clause 8.2. Vibration type : A Directions : 2 hrs each in X, Y and Z directions. Total : 6 hrs Frequency range : 10 to 55 to 10 Hz (1min.) Amplitude : 1.5mm Mounting method : Soldering onto printed board Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.											

Item	Specified Value									Test Methods and Remarks
	LEM2520	LB3218 LB2518 LB2016 LB2012 LB1608 LBMF1608	LBC2518 LBC2016 LBC2012	LBR2518 LBR2012	CB2518 CB2016 CB2012	CBC3225 CBC2518 CBC2016 CBC2012	CBL2012	CBMF1608	LBM2016	
14.Drop test	Inductance change : Within ±5% No significant abnormality in appearance.									LEM : Acceleration : 980m/sec ² Duration : 6msec Number of times : 6 sides × 3 times Mounting method : Soldering onto printed board Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.
15.Solderability	At least 90% of surface of terminal electrode is covered by new solder.									LEM : Solder temperature : 230±5°C Duration : 5±0.5sec. Flux : Methanol solution with 25% of colophony LB · LBC · LBR · CB · CBC · CBL · LBM · LBMF · CBF : Solder temperature : 245±5°C Duration : 5±0.5sec Flux : Methanol solution with 25% of colophony
16.Resistance to soldering heat	Inductance change : Within ±10% No significant abnormality in appearance.	LB3218 LB2518 LB2016 LB2012 LB1608 Inductance change : Within ±10% No significant abnormality in appearance. LBMF1608 Inductance change : Within ±20% No significant abnormality in appearance.	Inductance change : within ±10% No significant abnormality in appearance.			Inductance change : Within ±20% No significant abnormality in appearance.	Inductance change : Within ±5% No significant abnormality in appearance.	LEM : Reflow condition 3 times of reflow over at 220±5°C for 40sec. MAX, With Peak temperature at 240±5°C for 5 sec. MAX. (Refer to a Profile of chart below.)  Flow condition Solder temperature : 260±5°C Duration : 10±1sec. Once LB · LBC · LBR · CB · CBC · CBL · LBM · LBMF · CBF : 3 times of reflow oven at 230°C MIN for 40sec. with peak temperature at 260 ⁺⁰ ₋₅ °C for 5sec.		
17.Resistance to solvent	No significant abnormality in appearance									Solvent temperature : Room temperature Type of solvent : Isopropyl alcohol (LEM2520 · LB · LBC · LBR · CB · CBC · CBL · LBM · LBMF · CBF) Cleaning conditions : 90s. Immersion and cleaning. (LEM2520 · LB · LBC · LBR · CB · CBC · CBL · LBM · LBMF · CBF)

Item	Specified Value									Test Methods and Remarks									
	LEM2520	LB3218 LB2518 LB2016 LB2012 LB1608 LBMF1608	LBC2518 LBC2016 LBC2012	LBR2518 LBR2012	CB2518 CB2016 CB2012	CBC3225 CBC2518 CBC2016 CBC2012	CBL2012	CBMF1608	LBM2016										
18. Thermal shock	Inductance change : Within ±10% Q→ R12~4R7 : 30min. 5R6~330 : 25min. 390~820 : 20min. 101 : 15min.	Inductance change :Within ±10% No significant abnormality in appearance.								LEM : Conditions for 1 cycle <table border="1"> <tr> <th>Step</th> <th>Temperature (°C)</th> <th>Duration (min)</th> </tr> <tr> <td>1</td> <td>-40</td> <td>30</td> </tr> <tr> <td>2</td> <td>+85</td> <td>30</td> </tr> </table> Number of cycle : 100 cycle Recovery : At least 1 hr of recovery the standard condition after the removal from test chamber, followed by the measurement within 2 hrs. LB · LBC · LBR · CB · CBC · CBL · LBM · LBMF · CBFM : -40~+85°C, maintain times 30min, 100 cycle Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	Step	Temperature (°C)	Duration (min)	1	-40	30	2	+85	30
Step	Temperature (°C)	Duration (min)																	
1	-40	30																	
2	+85	30																	
19. Damp heat	Inductance change : Within ±10% Q→ R12~4R7 : 30min. 5R6~330 : 25min. 390~820 : 20min. 101 : 15min.	Inductance change :Within ±10% No significant abnormality in appearance.								Temperature : 60±2°C Humidity : 90~95%RH Duration : 1000 hrs Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.									
20. Loading under damp heat	Inductance change : Within ±10% Q→ R12~4R7 : 30min. 5R6~330 : 25min. 390~820 : 20min. 101 : 15min.	Inductance change : Within ±10% No significant abnormality in appearance.								LEM · LB · LBC · CB · CBC · CBL · LBM · LBMF · CBFM : Temperature : 60±2°C Humidity : 90~95%RH Duration : 1000 hrs Applied current : Rated current Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.									
21. High temperature life test	Inductance change : Within ±10% Q→ R12~4R7 : 30min. 5R6~330 : 25min. 390~820 : 20min. 101 : 15min.	/			Inductance change :Within ±10% No significant abnormality in appearance.				LEM · CB · CBC · CBL · LBM · CBFM : Temperature : 85±2°C Duration : 1000 hrs Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.										
22. Loading at high temperature		Inductance change :Within ±10% No significant abnormality in appearance.			/				LB · LBC · LBR · LBMF : Temperature : 85±2°C Duration : 1000 hrs Applied current : Rated current Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.										

Item	Specified Value									Test Methods and Remarks
	LEM2520	LB3218 LB2518 LB2016 LB2012 LB1608 LBMF1608	LBC2518 LBC2016 LBC2012	LBR2518 LBR2012	CB2518 CB2016 CB2012	CBC3225 CBC2518 CBC2016 CBC2012	CBL2012	CBMF1608	LBM2016	
23.Low temperature life test	Inductance change : Within±10% Q→ R12~4R7 : 30min. 5R6~330 : 25min. 390~820 : 20min. 101 : 15min.	Inductance change :Within±10% No significant abnormality in appearance.								LEM・LB・LBC・LBR・CB・CBC・CBL・LBM・LBMF・CBMF Temperature : -40±2℃ Duration : 1000 hrs Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.
24.Standard condition	Standard test condition : Unless otherwise specified,temperature is 20±15℃, and 65±20% of relative humidity.When there are question concerning measurement result : In order to provide correlation date, the test shall be condition of 20±2℃ of temperature, 65±5% relative humidity. Inductance is in accordance with our measured value.									

LEM Type, LB Type, CB Type

Stages	Precautions	Technical considerations																																				
1.Circuit Design	<p>Operating environment,</p> <p>1.The products described in this specification are intended for use in general electronic equipment,(office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.</p>																																					
2.PCB Design	<p>Land pattern design</p> <p>1.Please contact any of our offices for a land pattern, and refer to a recommended land pattern of a right figure or specifications.</p>	<p>PRECAUTIONS</p> <p>【Recommended Land Patterns】</p> <p>Surface Mounting</p> <ul style="list-style-type: none"> Mounting and soldering conditions should be checked beforehand. Applicable soldering process to this products is reflow soldering only. <p>Unit : mm</p> <p>Recommended Land Patterns</p>  <table border="1"> <thead> <tr> <th>TYPE</th> <th>A</th> <th>B</th> <th>C</th> </tr> </thead> <tbody> <tr> <td>1608</td> <td>0.55</td> <td>0.7</td> <td>1.0</td> </tr> <tr> <td>MF1608</td> <td>0.55</td> <td>0.8</td> <td>1.0</td> </tr> <tr> <td>2012</td> <td>0.7</td> <td>0.8</td> <td>1.45</td> </tr> <tr> <td>2016</td> <td>0.7</td> <td>0.8</td> <td>1.8</td> </tr> <tr> <td>2518</td> <td>0.8</td> <td>1.2</td> <td>2.0</td> </tr> <tr> <td>LEM2520</td> <td>0.9</td> <td>1.5</td> <td>1.5</td> </tr> <tr> <td>3218</td> <td>1.0</td> <td>1.6</td> <td>2.0</td> </tr> <tr> <td>3225</td> <td>1.0</td> <td>1.6</td> <td>2.7</td> </tr> </tbody> </table>	TYPE	A	B	C	1608	0.55	0.7	1.0	MF1608	0.55	0.8	1.0	2012	0.7	0.8	1.45	2016	0.7	0.8	1.8	2518	0.8	1.2	2.0	LEM2520	0.9	1.5	1.5	3218	1.0	1.6	2.0	3225	1.0	1.6	2.7
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3.Considerations for automatic placement	<p>Adjustment of mounting machine</p> <p>1.Excessive impact load should not be imposed on the products when mounting onto the PC boards.</p> <p>2.Mounting and soldering conditions should be checked beforehand.</p>	<p>1. When installing products, care should be taken not to apply distortion stress as it may deform the products.</p>																																				
4.Soldering	<p>Wave soldering (LEM Type only)</p> <p>1.For wave soldering,please apply conditions meeting the range of the specified conditions in our catalog or the relevant specifications.</p> <p>Reflow soldering (LB and CB Types)</p> <p>1.For reflow soldering with either leaded or lead-free solder,the profile specified in "point for controlling" is recommended.</p> <p>Reflow soldering (LEM)</p> <p>1.For reflow soldering, please apply conditions meeting the range of the specified conditions in our catalog or the relevant specifications.</p> <p>Recommended conditions for using a soldering iron</p> <p>1.Put the soldering iron on the land-pattern. Soldering iron's temperature-Below 350°C Duration-3 seconds or less The soldering iron should not come in contact with inductor directly.</p>	<p>1.Components can be damaged by excessive heat whre soldering conditions exceed the specified range.</p> <p>1.Reflow profile</p>  <p>1.Components can be damaged by excessive heat whre soldering conditions exceed the specified range.</p>																																				
5.Cleaning	<p>Cleaning conditions</p> <p>LEM Type, LB Type, CB Type</p> <p>1.Washing by supersonic waves shall be avoided.</p>	<p>LEM Type, LB Type, CB Type</p> <p>1.If washing by supersonic waves, supersonic waves may cause broken products.</p>																																				
6.Handling	<p>Handling</p> <p>1.Keep the inductors away from all magnets and magnetic objects.</p> <p>Breakaway PC boards (splitting along perforations)</p> <p>1.When splitting the PC board after mounting inductors, care should be taken not to give any stresses of deflection or twisting to the board.</p> <p>2.Board separation should not be done manually, but by using the appropriate devices.</p> <p>Mechanical considerations</p> <p>1.Please do not give the inductors any excessive mechanical shocks.</p>	<p>1.There is a case that a characteristic varies with magnetic influence.</p> <p>1.Planning pattern configurations and the position of products should be carefully performed to minimize stress.</p> <p>1.There is a case to be damaged by a mechanical shock.</p>																																				
7.Storage conditions	<p>Storage</p> <p>1.To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.</p> <p>Recommended conditions</p> <p>Ambient temperature 0~40°C Humidity Below 70% RH</p> <p>The ambient temperature must be kept below 30°C Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, LE type inductors should be used within one year from the time of delivery.</p> <p>LB type Please should be used within 6 months from the time of delivery.</p> <p>LE type In case of storage over 6 months, solderability shall be checked before actual usage.</p>	<p>1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.</p>																																				